# IoT SuperServer SYS-210SE-31D





# **Key Applications**

- Multi-Access Edge Computing
- Flex-RAN, Open-RAN vBBU
- Telecom DRAN, CRAN, and Edge Core Application
- Enterprise Edge Computing

### **Key Features**

#### Three hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Single Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processor (per node)
- 2. 8 DIMMs; Up to 2TB 3DS ECC DDR4-3200: RDIMM/LRDIMM (per node)
- 3. 2 PCI-E Gen4 x16 FHHL slot and 1 PCI-E Gen4 x16 HHHL slot (per node)
- 4. 2 NVMe M.2 2280/22110 (per node)
- 5. 4 counter-rotated fan speed control (per node); 1 Air Shroud (per node)
- 6. Front-access 1+1 Redundant 2000W DC Power Supplies

Chassis

# Specifications

#### **Product SKUs**

SYS-210SE-	<ul> <li>SuperServer SYS-210SE-31D</li></ul>
31D	(Silver)

Motherboard

# Super X12SPED-F

Processor (per Node)

CPU	<ul> <li>Single Socket P+ (LGA-4189)</li> <li>3rd Gen Intel® Xeon® Scalable processors</li> <li>Support CPU TDP 85-205W</li> </ul>
	Three hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:
	<ul> <li>Please contact Supermicro Technical Support for supporting conditions of high power (TDP &gt;205W) processors.</li> </ul>
Cores	■ Up to 32C/64T; Up to 48MB Cache

## System Memory (per Node)

Memory	<ul> <li>Memory Capacity: 8 DIMM slots</li> <li>Memory Type: 3200MHz ECC DDR4 RDIMM/LRDIMM</li> </ul>
Memory Voltage	∎ 1.2 V
Error Detection	ECC

#### **On-Board Devices (per Node)**

Chipset	Intel <sup>®</sup> C621A
Network Connectivity	1x 1GbE BaseT port(s)
IPMI	<ul> <li>Support for Intelligent Platform Management Interface v.2.0</li> <li>IPMI 2.0 with virtual media over LAN and KVM-over-LAN support</li> </ul>

### Input / Output (per Node)

LAN	<ul> <li>1 RJ45 GbE LAN port (Shared NIC</li> </ul>
Video	1 VGA port(s)
Serial Port	1 COM Port(s) (1 COM)
Others	<ul> <li>1 KVM dongle (output VGA x1, COM x1, USB 2.0 x2 through KVM cable)</li> </ul>

### Management

Software	SuperDoctor® 5
	IPMI 2.0

https://www.supermicro.com/en/products/system/IoT/2U/SYS-210SE-31D

Form Factor	■ 2U Rackmount
Model	CSE-SE201-R2K06P
Note	<ul> <li>16.9" (430mm) chassis depth</li> <li>Front access IO design, and tool less serviceability</li> <li>Three front hot-swappable nodes with single CPU socket and 8 DIMM design</li> </ul>

### **Dimensions and Weight**

Height	∎ 3.5" (88mm)
Width	∎ 17.7" (449mm)
Depth	∎ 16.9" (430mm)
Package	∎ 9.5" (H) x 29.5" (W) x 23.2" (D)
Weight	<ul> <li>Net Weight: 55.1 lbs (25 kg)</li> <li>Gross Weight: 70.6 lbs (32 kg)</li> </ul>
Available Color	∎ Silver
Front Panel	
Buttons	<ul><li>Power On/Off</li><li>UID button</li></ul>
LEDs	<ul> <li>HDD activity</li> <li>LAN1 activity</li> <li>LAN2 activity</li> <li>Power status</li> </ul>

#### System information

# **Expansion Slots (per Node)**

PCI-Express	<ul> <li>Slot 1: 1 PCIe PCI-E 4.0 x16 LP</li> <li>Slot 2: 1 PCIe PCI-E 4.0 x16</li></ul>
(PCI-E)	FHHL <li>Slot 3: 1 PCIe PCI-E 4.0 x16</li>
	FHHL

Drive Bays / Storage (per Node)

Drive Bays	<ul> <li>N/A</li> </ul>
M.2	<ul><li>2 M.2 NVMe</li><li>M-Key, 2280/22110</li></ul>

### **System Cooling**

Fans	<ul> <li>12 heavy duty fans with optimal fan speed control (4 fans per node)</li> </ul>
Air Shroud	∎ 1 Air Shroud(s)

#### **Power Supply**

### 2000W Redundant DC -48V Power Supplies with PMBus

Total Output	∎ 2000W : (-44) - (-60) Vdc
Power	

SYS-210SE-31D | 2U | SuperServer | Products | Super Micro Computer, Inc.

Power Configurations	<ul> <li>ACPI Power Management</li> <li>Power-on mode for AC power recovery</li> </ul>
PC Health Monito	ring

CPU	<ul> <li>Monitors for CPU Cores, Chipset Voltages, Memory</li> </ul>			
FAN	<ul> <li>Fans with tachometer monitoring</li> <li>Pulse Width Modulated (PWM) fan connectors</li> <li>Status monitor for speed control</li> </ul>			
Temperature	<ul> <li>CPU thermal trip support, PEPI</li> <li>Monitoring for CPU and chassis environment</li> </ul>			

Dimension (W x H x L)	∎ 73.5 x 40 x 265 mm			
+12V	∎ Max: 166.6A			
12V SB	∎ Max: 4A			
Certification				
[ Test Report ]				

**Operating Environment** 

Environmental Spec.	<ul> <li>Operating Temperature: 0°C ~ 55°C (32°F ~ 131°F)</li> <li>Non-operating Temperature: -40°C to 70°C (-40°F to 158°F)</li> <li>Operating Relative Humidity:</li> </ul>
	<ul> <li>Solution (non-condensing)</li> <li>Non-operating Relative Humidity: 5% to 95% (non-condensing)</li> </ul>

# **Parts List**

# Parts List - (Items Included)

	Part Number	Qty	Description
Motherboard / Chassis	MBD-X12SPED-F	3	Super X12SPED-F Motherboard
	CSE-SE201-R2K06P	1	2U Chassis
Add-on Card / Module	AOM-BPN-SE3N-P	1	Backplane for SuperEdge 2U3N,RoHS
Cable 1	CBL-0218L	1	11.5CM KVM/SUVI 36PIN TO 9PIN/15PIN/2USB
Cable 2	CBL-PWEX-1058	2	48VDC input power cable for PWS-2K03D-1R, 4M, 8AWG,RoHS
Riser Card	RSC-W-66G4	3	1U LHS WIO Riser card with two PCI-E 4.0 x16 slots,HF,RoHS
Riser Card	RSC-WR-6	3	1U RHS WIO Riser card with one PCI-E 4.0 x16 slot,HF,RoHS
Software	SFT-OOB-LIC	3	License key for enabling OOB BIOS management
Heatsink / Retention	SNK-P1044V	3	1U Passive CPU Heat Sink for B12 ICX/CPX CPU
*Power Supply	PWS-2K06F-1R	2	2000W 1U -48Vdc single output Redundancy power supply
*Power Distributor	PDB-PT201-DSG	2	Super Edge pass through board support Ultra powers up to 6KW
*Rail Set	MCP-290-20101-0N	1	2U fixed rail set, quick release, default for 2,3U , 17.6"W, 18.5- 22

#### Notes:

 Parts with \* are inside the chassis
 Excessive parts might not be shipped, including but not limited to excessive drive trays, fans, riser brackets, air shrouds, IO shields, cables.....etc.

### **Optional Parts List**

	Part Number	Qty	Description
TPM security module	<u>AOM-TPM-9670V</u>	-	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor